## **Product Specification**

## 深圳臺華達科技有限公司

SHENZHEN THD Electronics Co., Ltd.



# Product.No HD1252—xxWR—

Pitch=1.25mm Wafer Connector (Mated Height Contact)

А	Release		
Rev.	Description		
Approved Signatures			
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## **■**Scope

This specification covers the 1.25 mm Pitch Wafer Connector THD1252 series.

#### **■**Ordering information

## THD1252 - xx wR- SN

1	2	3	4
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0	Series name: HC601		
2	Number of contacts: 2 TO 20	4	Plating: GF= 1µ"~3µ" Gold Flash
8	Contact type: WR:Right Angle SMT WV:Vertical Angle SMT	•	G3= $3\mu''$ Gold over Nickel G5= $5\mu''$ Gold over Nickel SN= Tin(Lead Free) over Nickel

## Rating

Item	Standard
Voltage Rating(Max.)	50V AC
Current Rating(Max.)	0.5A DC
Operating Temperature Range	-55°C ~ +85°C (Including terminal temperature rise)

## ■ Material

Housing	Actuator	Terminal	Solder pin	Plating
L.C.P (UL94V-0)		G.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	2 11	Tin(Lead Free)
Color:White		Copper alloy	Copper alloy	over Nickel

#### **■**Performance

Item	Test Condition	Specification		
Contact Resistance	Mate applicable FPC and measure by dry circuit, 20mV Max, 1mA.	100	mΩ Max.	
Insulation Resistance	Mate applicable FPC and apply 500V DC between adjacent terminal or ground.	50 1	MΩ Min.	
Dielectric Strength	Mate applicable FPC, apply 250V AC(rms) for 1 minute between adjacent terminal or ground.	No B	reakdown	
FPC Retention Force	Insert the actuator, pull the FPC at a rate of 25±3mm per minute.	Per pin	x 0.15N Min.	
Terminal Retention Force	Apply axial pull out force at the rate of 25±3 mm/minute on the terminal assembled in the housing.	Per pin x 0.06Kgf {0.6N} Min.		
	Mate connectors and subject to the following vibration	Appearance	No Damage	
Vibration	conditions, for period of 2 hours in each of 3 mutually perpendicular axes, passing DC 1mA during the test.	Contact Resistance	100 mΩ Max.	
	Amplitude: 1.5mm P-P Frequency: 10~55~10 Hz in 1 minute. Duration: 2 hours in each of X,Y,Z axes.	Discontinuity	1 μsec Max.	
	Mate applicable FPC and subject to the following shock conditions. 3 times of shocks shall be applied for each	Appearance	No Damage	
Shock	6 directions along 3 mutually perpendicular axes, passing DC 1 mA current during the test.	Contact Resistance	100 mΩ Max.	
	Peak value : 490m/s <sup>2</sup> {50G}	Discontinuity	1 μsec Max.	
Salt Spray	Mate applicable FPC and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water, after which the specified measurements shall be performed.	Appearance	No Damage	
oure oping	NaCl solution Concentration : $5 \pm 1\%$ Spray time : $48 \pm 4$ hours Ambient temperature : $35 \pm 2$ °C	Contact Resistance	100 mΩ Max.	

Item	Test Condition		Specification	
	Mate applicable FPC and expose to 85±2°C for 96 hours. Upon completion of the exposure period, the test	Appearance	No Damage	
Heat Resistance	specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Contact Resistance	100 mΩ Max.	
	Mate applicable FPC and expose to $-40\pm2^{\circ}$ C for 96 hours. Upon completion of the exposure period, the test		No Damage	
Cold Resistance	specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Contact Resistance	100 mΩ Max.	
		Appearance	No Damage	
Hami di ta	Mate applicable FPC and expose to 60 $\pm$ 2°C, relative humidity 90 to 95% for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Contact Resistance	100 mΩ Max.	
Humidity		Dielectric Strength	No Breakdown	
		Insulation Resistance	50 MΩ Min.	
Temperature Rise	Mate applicable FPC and measure the temperature rise of contact when the maximum AC rated current is passed.	Temperature rise	30°C Max.	
	Mate applicable FPC and subject to the following conditions for 5 cycles. Upon completion of the exposure period, the test	Appearance	No Damage	
Temperature Cycling	specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.  1 cycle     a) -55±3°C	Contact Resistance	100 mΩ Max.	
Solderability	Tip of solder tails and fitting nails into the molten solder (held at $245\pm5^{\circ}\text{C}$ ) up to 0.1mm from the bottom of the housing for $3\pm0.5$ seconds.	Solder Wetting	95% of immersed area must show no voids, pin holes.	
Resistance to Soldering	When reflowing refer to Infrared reflow condition Soldering iron method  0.2mm from terminal tip and fitting nail tip.  Soldering time : 5 seconds Max.  Solder temperature : 370~400°C	Appearance	No Damage	

## ■ Recommended Temperature Profile





